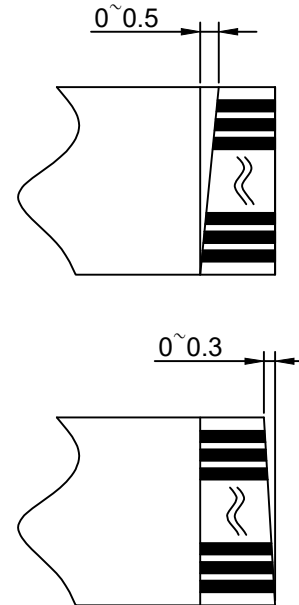
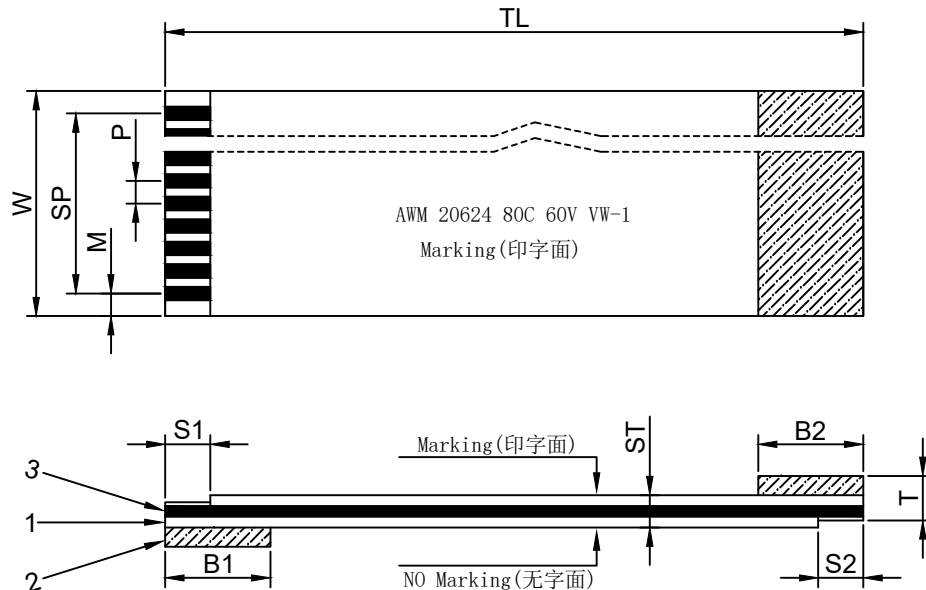


EDITION	SUMMARY OF CHANGES				ISSUE DATE
A0	新版发行				2026/01/12



STRUCTURE (构造)				
NO.	ITEM (项目)	SPECIFICATION (规格)		
1	INSULATION (胶膜)	印字膜:通用版20624 (43μm)		
		白膜:80° C 60V (43μm)		
2	SUPPORTING TAPE (补强板)	225μm		Blue (蓝色)
3	CONDUCTOR (导体)	Thickness (厚度)	0.035	±0.005
		Width (宽度)	0.65	±0.03
4	CONDUCTOR (导体镀层)	PLATED (电镀)	锡Sn (1μm)	MIN
		PLATED (电镀)		

DIMENSION (尺寸)			
No. of conductors (导体数目)	N	(N) P	
Pitch (间距)	P	1.0	±0.06
Span (总间距)	SP	(N-1)*1	±0.1
Width (总宽度)	W	(N+1)*1	±0.12
Margin (边缘宽度)	M	1.0	±0.12
Total length (总长度)	TL	(TL)	±2.0
Insert Thickness (插接端厚度)	T	0.3	±0.03
Surface Thickness (线身厚度)	ST	0.121	±0.03
Strip Length (裸铜长度)	S1	4.0 4/3可定做	±0.5
	S2	4.0 4/3可定做	±0.5
Supporting Tape Length (补强板长度)	B1	8.0 8/6/5/4/可定做	±1.0
	B2	8.0 8/6/5/4/可定做	±1.0

技术要求:

- 1、保存环境: 温度15~25℃ 湿 度: 30~50RH%
- 2、保质期: 镀金: 12个月 镀锡: 6个月
- 3、产品符合ROHS 2.0标准

DESIGN:		Xiping Huang			广东国连电子有限公司		
CHECK:		Ke Tian			GUANGDONG GUOLIAN ELECTRONICS CO.,LTD		
APPROVED:		Youquan Xu		TITLE:			
DIM		TOL	DIM	TOL	FFC CABLE B型		
X.		±0.25	X°		PART NO.		
X. X		±0.20	X°	±3.0°	1.0*NP*TL*B (4/4/6/6) (0.035*0.65)		
X. XX		±0.15	X. X°		REV. A		
X. XXX			X. XX°				SCALE: N/A
			X. XXX		UNIT: mm	SHEET: 1/1	